General Description

The SJH015N04 uses SGT technology to provide excellent $R_{DS(ON)}$, low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

Features

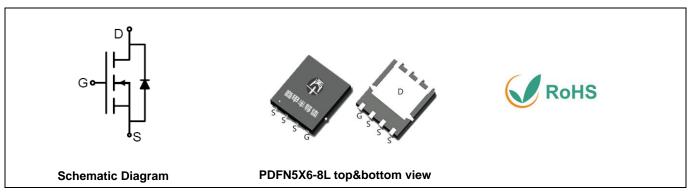
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Load Switching, Quick/Wireless Charging, Motor Driving

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	40	V
R _{DS(ON)_TYP}	1.6	mΩ
I _D	170	А
Q _G	51.8	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJH015N04	SJH015N04	PDFN5X6-8L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	40	V
V _G S	Gate-Source Voltage (V _{DS} =0V)	±20	V
l-	Drain Current-Continuous(T _C =25℃)	170	А
I _D	Drain Current-Continuous(Tc=100℃)	107	А
I _{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	680	А
P _D	Maximum Power Dissipation(Tc=25°C)	96	W
PD	Maximum Power Dissipation(Tc=100°C)	38	W
Eas	Avalanche energy (Note 2)	380	mJ
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 To 150	င

Table 2. Thermal Characteristic

S	ymbol	Parameter	Тур	Max	Unit
	R _θ JC	Thermal Resistance, Junction-to-Case		1.3	°C/W



Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

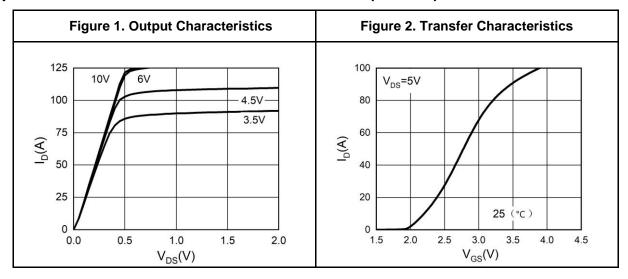
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	40			V
	7 0 1 1/1 1 1 1 1 1	V _{DS} =40V, V _{GS} =0V T _J =25°C			1	μA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =40V, V _{GS} =0V T _J =125°C			100	μΑ
Igss	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	1		2.5	V
g FS	Forward Transconductance	V _{DS} =5V, I _D =20A		61		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A T _J =25°C		1.6	2.1	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =20A T _J =25°C		2.2	2.9	mΩ
Dynamic Chara	cteristics					
Ciss	Input Capacitance			3565		pF
Coss	Output Capacitance	V _{DS} =20V,V _{GS} =0V, f=1.0MHz		1712		pF
Crss	Reverse Transfer Capacitance			108		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		1.9		Ω
Switching Para	meters		•	•		
t _{d(on)}	Turn-on Delay Time			15.2		nS
t _r	Turn-on Rise Time	V _{GS} =10V, V _{DS} =20V,		7.6		nS
$t_{d(off)}$	Turn-Off Delay Time	R _L =1Ω, R _{GEN} =3Ω		48.4		nS
t _f	Turn-Off Fall Time			13.6		nS
Qg	Total Gate Charge			51.8		nC
Q _{gs}	Gate-Source Charge	V _{GS} =10V, V _{DS} =20V, I _D =20A		10		nC
Q_{gd}	Gate-Drain Charge			7.8		nC
Source-Drain D	iode Characteristics			•		•
I _{SD}	Source-Drain Current (Body Diode)				170	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =20A			1.2	V
t _{rr}	Reverse Recovery Time	I _F =20A, dI/dt=100A/μs		43.8		ns
Qrr	Reverse Recovery Charge	I _F =20A, dI/dt=100A/μs		32.6		nC
	•					

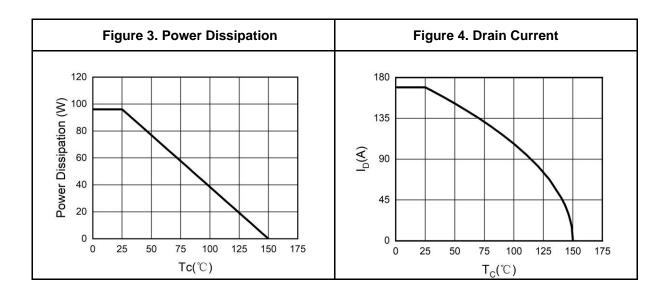
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature. Notes 2.E_{AS} condition: T_J=25 °C,V_{DD}=40V,V_G=10V, Rg=25 Ω , L=0.5mH.

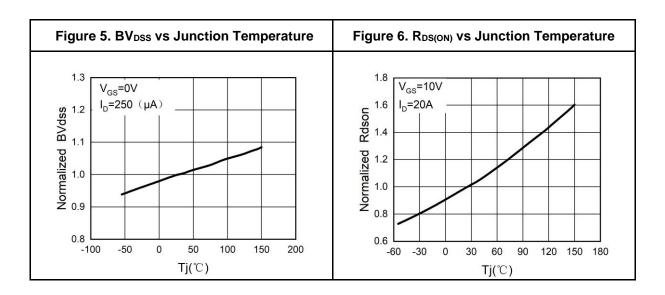
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



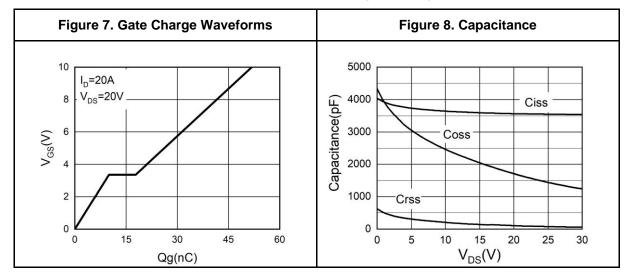
Typical Electrical And Thermal Characteristics (Curves)

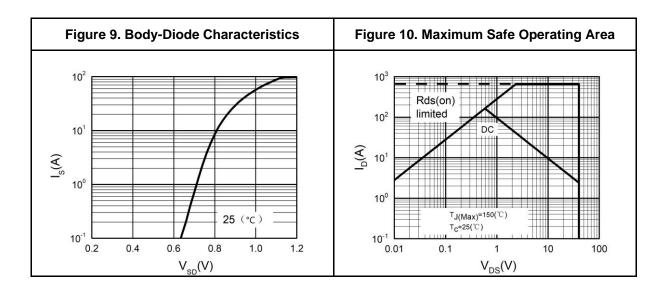






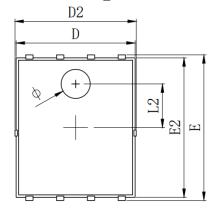
Typical Electrical And Thermal Characteristics (Curves)

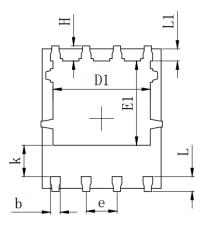




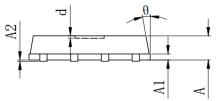


PDFN5X6-8L Package Information





SYMBOL	MILLIMETER			
SIMBOL	MIN	Typ.	MAX	
Α	0. 900	1.000	1.100	
A1		0. 254 REF.		
A2		0~0.05		
D	4. 824	4. 900	4. 976	
D1	3. 910	4.010	4.110	
D2	4. 924	5.000	5. 076	
E	5. 924	6.000	6.076	
E1	3. 375	3. 475	3. 575	
E2	5. 674	5. 750	5.826	
b	0. 350	0.400	0.450	
e		1.270 TYP.		
L	0. 534	0.610	0.686	
L1	0. 424	0.500	0. 576	
L2		1.800 REF.		
k	1. 190	1. 290	1.390	
Н	0. 549	0. 625	0.701	
θ	8°	10°	12°	
ф	1.100	1. 200	1.300	
d			0. 100	



Complete	MILLIMETER					
Symbol	Min.	Тур.	Max.			
А	0.900	1.000	1.100			
A1		0.254 REF.				
A2		0~0.05				
D	4.824	4.900	4.976			
D1	3.910	4.010	4.110			
D2	4.924	5.000	5.076			
E	5.924	6.000	6.076			
E1	3.375	3.475	3.575			
E2	5.674	5.75	5.826			
b	0.350	0.400	0.450			
е	1.270 TYP.					
L	0.534	0.610	0.686			
L1	0.424	0.500	0.576			
L2		1.800 REF.				
k	1.190	1.290	1.390			
Н	0.549	0.625	0.701			
θ	8°	10°	12°			
Ф	1.100	1.200	1.300			
d			0.100			



Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor

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